

General Description

The MAXQ3108 is a low-power microcontroller that features two high-performance MAXQ20 cores: a dedicated core (DSPCore) for intensive data processing and a user core (UserCore) for supervisory functions. The two cores can operate at different clock speeds, allowing lower system power consumption for even processing intensive applications. The UserCore can be configured to run at the lowest clock rate possible for monitoring the peripherals for communication activities, while the DSPCore runs at the highest speed. Each core has access to an independent math accelerator (a multiply/accumulate unit). The UserCore supports SPI™, I 2C, two UART channels with one channel supporting IR carrier modulation, a trimmable real-time clock (RTC), battery-backed RTC registers, and data memory. The DSPCore is fully user programmable and configurable. With the standard 32,768Hz crystal, the DSPCore operates at 10.027MHz, while the UserCore runs at 5.014MHz.

> Applications Electricity Meters Industrial Control Battery-Powered and Portable Devices Smart Transmitters Medical Instrumentation

Features

♦ **High-Performance, Low-Power, Dual 16-Bit RISC Cores**

- ♦ **Approaches 1MIPS per MHz**
- ♦ **System Clock** 10.027MHz (DSPCore) 5.014MHz (UserCore)
- ♦ **33 Instructions**
- ♦ **Approximately 100ns Execution Time at 10.027MHz**
- ♦ **Three Independent Data Pointers Accelerate Data Movement with Automatic Increment/Decrement**
- ♦ **16-Bit Instruction Word, 16-Bit Data Bus**
- ♦ **16 x 16-Bit General-Purpose Working Registers for Each Core**
- ♦ **16-Level Hardware Stack for Each Core**
- ♦ **Hardware Support for Software Stack**
- ♦ **Memory Features**

UserCore

64KB Flash Program Memory 16B Battery-Backed (VBAT) Data SRAM 4KB Utility ROM

2KB Data SRAM; 10KB Total Data SRAM (If DSPCore Inactive)

DSPCore

8KB User-Loadable SRAM Code Memory 1KB Data SRAM

♦ **Peripherals**

FLL (10MHz Output with 32kHz Input)

SPI Master, I²C Master

Two UART Channels (One Supports IR Carrier Modulation)

- Math Accelerator for Each Core
- Three Manchester Decoder and Cubic Sinc Filter Channels for Interfacing to DS8102 Delta-Sigma **Modulators**
- Two 16-Bit Programmable Timer/Counters
- RTC with Alarms and Digital Trim, Dedicated Battery-Backup Pin (VBAT)

Two Programmable Pulse Generators

Independent Watchdog Timer for Each Core External Interrupts

JTAG Interface

♦ **Operating Modes**

Stop Mode: 0.1µA typ Active Current at 10MHz and $V_{DD} = 2.0V$: 1.0mA typ

Ordering Information

+Denotes a lead(Pb)-free/RoHS-compliant package.

Pin Configuration appears at end of data sheet.

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Note: Some revisions of this device may incorporate deviations from published specifications known as errata. Multiple revisions of any device may be simultaneously available through various sales channels. For information about device errata, go to: **www.maxim-ic.com/errata**.

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For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

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ABSOLUTE MAXIMUM RATINGS

Voltage Range on Any Pin except VDD with Respect to VSS-0.3V to VDD Voltage Range on V_{DD} with Respect to V_{SS}-0.3V to +3.6V Operating Temperature Range-40°C to +85°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

RECOMMENDED DC OPERATING CONDITIONS

(V_{DD} = V_{RST} to 3.6V, T_A = -40°C to +85°C.) (Notes 1, 2)

RECOMMENDED DC OPERATING CONDITIONS (continued)

 $(V_{\text{DD}} = V_{\text{RST}}$ to 3.6V, $T_A = -40^{\circ}C$ to $+85^{\circ}C$.) (Notes 1, 2)

Note 1: Results based on simulation data. Characterization data will be available at a later date. All voltages are referenced to ground. Specifications to $T_A = -40^\circ \text{C}$ are guaranteed by design and are not production tested.

Note 2: Typical values are not guaranteed. These values are measured at room temperature, V_{DD} = 3.3V.

Note 3: This current is from V_{BAT} only if (V_{DD} < V_{BAT} and V_{DD} < V_{RST}) or (STOP = 1, REGEN = 0, BOD = 1). Otherwise, this current is from V_{DD}.

Note 4: Measured on the V_{DD} pin and the device not in reset. All inputs are connected to V_{SS} or V_{DD}. Outputs do not source/sink any current. Timer enabled, RTC enabled, part executing JUMP \$ from flash.

Note 5: If the RTC is on for parameters ISTOP_2, ISTOP_3, and ISTOP_4, a current equal to I_{BAT1} is added to I_{DD}.

Note 6: The maximum total current, I _{OH(MAX)} and I _{OL(MAX)}, for all outputs combined should not exceed 35mA to satisfy the maximum specified voltage drop.

Note 7: The timing listed above is clocked by 63 cycles of the internal 1MHz ±5% clock. There will be ROM code overhead, which is a function of system clock. For data sheet purposes, a better way is to specify the limits that include ROM code execution with specified system clock speed.

Block Diagram

Pin Description

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Pin Description (continued)

Detailed Description

The MAXQ3108 microcontroller is an integrated, lowcost solution to simplify the design of electricity metering and industrial control products. Standard features include two highly optimized, single-cycle, MAXQ 16-bit RISC microcontroller cores; 64KB of flash memory, 11KB RAM, and independent hardware stacks; general-purpose registers; and data pointers for each core. Application-specific peripherals include hardware SPI and I2C masters, real-time clock, programmable pulse generators, dual UARTs (one of which that supports IR carrier frequency modulation), and math accelerators.

At the heart of the MAXQ3108 are two MAXQ20 16-bit RISC microcontrollers. The dual-core approach allows one core (DSPCore) to be entirely dedicated to collection and processing of AFE samples for the metering function, while the second core handles any communication and user-specific administrative functions. The MAXQ3108 DSPCore operates at 10.027MHz with the default crystal and almost all instructions execute in a single clock cycle (100ns), while the UserCore runs at half that frequency (5.014MHz).

The dual-core strategy promotes flexibility by allowing the update of metering routines and parameters separately in DSPCore code and data memory. Furthermore, an independent DSPCore solely responsible for accurate metering introduces a measure of safety and reliability since all administrative/communication functions and interruptions are handled by the UserCore. Both cores feature standard MAXQ power-saving system

clock-divide modes and independently implement lowpower stop (UserCore) and idle (DSPCore) modes. The DSPCore implements an idle mode that allows CPU execution to be halted while awaiting an ADC sample. The UserCore implements an ultra-low-power stop mode that automatically disables the DSPCore and results in a quiescent current consumption of less than 1.5∝A. The combination of high performance and corespecific low-power mode implementation provides increased power efficiency and capability over competitive microcontrollers.

Microprocessor

The MAXQ20 is a low-power implementation of the new 16-bit MAXQ family of RISC cores. The core supports the Harvard memory architecture with separate 16-bit program and data address buses, but also provides pseudo-Von Neumann support through utility ROM functions. A fixed 16-bit instruction is standard, but data can be arranged in 8 or 16 bits. The MAXQ20 core is implemented as a nonpipelined processor with single clock-cycle instruction execution. The data path is implemented around register modules, and each register module contributes specific functions to the core. The accumulator module consists of sixteen 16-bit registers and is tightly coupled to the arithmetic logic unit (ALU). Program flow is supported by a dedicated 16 level-deep hardware stack.

Execution of instructions is triggered by data transfer between functional register modules, or between a functional register module and memory. Since data

movement involves only source and destination modules, circuit switching activities are limited to active modules only. For power-conscious applications, this approach localizes power dissipation and minimizes switching noise. The modular architecture also provides maximum flexibility and reusability, which are important for a microprocessor used in embedded applications.

The MAXQ instruction set is designed to be highly orthogonal. All arithmetical and logical operations can use any register along with the accumulator. Data movement is supported from any register to any other register. Memory is accessed through specific data pointer registers with auto increment/decrement support.

Memory

The MAXQ3108 supports a pseudo-Von Neumann memory structure that can merge program and data into a linear memory map. This is accomplished by mapping the data memory into the program space or mapping the program memory segment into the data space. Memory access is under the control of the memory management unit (MMU). During flash programming, the MMU maps the flash memory into data space, and the built-in firmware provides necessary controls to the embedded flash memory for all read/erase/write operations when the ROM loader is invoked. Additionally, when the DSPCore is disabled, all its code SRAM (8KB) is mapped into the data SRAM space of the UserCore. This allows streamlined reconfiguration of the DSP code memory or a larger data SRAM for applications not employing DSPCore operation.

The MAXQ3108 incorporates the following:

- 4KB utility ROM
- 64KB program flash
- 2KB SRAM data memory
- 8KB program SRAM (DSPCore)
- 1KB SRAM data memory (DSPCore)

The MMU operates automatically and maps data memory as a function of the contents of the instruction pointer; that is, the execution location controls the structure of the data memory map. The only constraint is that no memory region is available as data when code is being fetched from that region. For example, when executing from flash, flash cannot be read as data. But changing the execution location to the utility ROM through a subroutine call allows the flash memory to be read as data.

Figure 1. Memory Map

DSP Program RAM

A 4K Word (8KB) section of memory is available to the DSPCore as code memory. When the DSPCore is disabled (as it is immediately following a reset event) that block of memory appears in the UserCore data memory map at location 0x1000. Thus, a typical startup sequence to operate both cores might include:

- 1) Low-level initialization of the UserCore.
- 2) Copy DSP code from program flash to DSPCore code RAM at 0x1000.
- 3) Enable DSPCore.
- 4) Poll mailbox registers to verify that DSPCore is correctly running.

For more information, see the Dual-Core Interfaces section.

Registers

The MAXQ family of microcontrollers uses a bank of registers to access memory and peripherals and to perform basic CPU activities. These registers are organized into as many as 16 register modules, each of which can have as many as 32 registers, giving a system maximum of 512 registers. The registers are divided into two sections: system registers (modules 7 to 15) and peripheral registers (modules 0 to 5).

Since the MAXQ3108 contains two MAXQ core processors, each has a set of system registers and a set of peripheral registers.

System Registers

The MAXQ3108 UserCore implements the standard set of system registers as described in the MAXQ Family User's Guide. The exceptions are listed below:

• In the IMR register, bit IM5 is not implemented since there is no module 5 implemented in the MAXQ3108.

Table 1. UserCore Peripheral Registers

- In the SC register, bits CDA1 and UPM are not implemented since the size of the memory in the device does not require their implementation.
- In the IIR register, bit II5 is not implemented since there is no module 5 implemented in the MAXQ3108.
- In the CKCN register, bits XT/RC, RGSL, and RGMD are not implemented. Instead, bits 5 and 6 are FLLMD and FLLSL, respectively. These bits support the frequency-locked loop (FLL) that forms a core part of the MAXQ3108 clocking scheme. More information is given in the Clock section.

The MAXQ3108 DSPCore system register complement is identical to that found in the UserCore, with these exceptions:

- In the IMR register, only IM0 is implemented.
- The system control (SC) register is not implemented.
- In the IIR register, only the IIO bit is implemented.
- The WDCN register is not implemented because there is no watchdog timer in the DSPCore. Watchdog functionality can be implemented in the UserCore by determining if the DSPCore is responding to messages.
- In the CKCN register, the STOP, RGSL, and SWB bits are not implemented because the corresponding functions do not exist in the DSPCore. The FLLMD and FLLSL bits are not implemented because a common clock block is shared with the UserCore, and the control bits here would be redundant.

Peripheral Registers—UserCore

The MAXQ3108 UserCore exposes its peripheral complement in five modules numbered 0 to 4. Table 1 describes the functions associated with the peripheral registers, and Table 2 shows the default values of these registers.

Table 1. UserCore Peripheral Registers (continued)

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Table 1. UserCore Peripheral Registers (continued)

Table 2. UserCore Peripheral Register Default Values

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Table 2. UserCore Peripheral Register Default Values (continued)

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Table 2. UserCore Peripheral Register Default Values (continued)

Peripheral Registers—DSPCore

The MAXQ3108 DSPCore exposes its peripheral complement in modules numbered 0 and 1. Table 3 describes the functions associated with the peripheral registers, and Table 4 shows the default values of these registers.

Table 3. DSPCore Peripheral Registers

REGISTER	MOD: REG	BIT															
		15	14	13	12	11	10	9	8	$\overline{7}$	6	5	4	3	$\mathbf{2}$		0
AD ₀	0:0	ADC0 Output Register															
AD ₁	0:1	ADC1 Output Register															
AD ₂	0:2	ADC2 Output Register															
AD ₃	0:3	ADC3 Output Register															
AD4	0:4	ADC4 Output Register															
AD ₅	0:5	ADC5 Output Register															
SRSP0	0:6											RSPSDV	REQE			RSPST	
SRSP1	0:7	Slave Response Register 1															
ADOLSB	0:8									ADC0 Output Register LSB							
AD1LSB	0:9									ADC1 Output Register LSB							
AD _{2LSB}	0:10		ADC2 Output Register LSB														
AD3LSB	0:11	ADC3 Output Register LSB															
AD4LSB	0:12	ADC4 Output Register LSB															
AD5LSB	0:13									ADC5 Output Register LSB							
MREQ0	0:14											REQCDV RSPIE				REQCM	
MREQ1	0:15	Master Request Register 1															
MREQ2	0:16	Master Request Register 2															
ADCN	0:17	IFCSEL	IF45E	IF23E	IF ₁₀ E	MDCKS	MD2E	MD _{1E}	MD0E		OSRI	ABF5	ABF4	ABF3	ABF ₂	ABF1	ABF0
ADCC	0:18	ADC Clock Correction Register															
MSTC	0:19												CCSL			MD2SNC MD1SNC MD0SNC	
MCNT	1:0									OF	MCW	CLD	SQU	OPCS		MSUB MMAC	SUS
MA	1:1	Multiplier Operand "A" Register															
MB	1:2	Multiplier Operand "B" Register															
MC ₂	1:3	Multiplier Accumulator Register 2 (MSB, bits 47-32)															
MC ₁	1:4		Multiplier Accumulator Register 1 (bits 31-16)														
MC ₀	1:5	Multiplier Accumulator Register 0 (LSB, bits 15-0)															

Table 3. DSPCore Peripheral Registers (continued)

Table 4. DSPCore Peripheral Register Default Values

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Special Function Register Bit Descriptions

Special Function Register Bit Descriptions (continued)

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AD0LSB.[7:0]:

Special Function Register Bit Descriptions (continued)

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Special Function Register Bit Descriptions (continued)

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Special Function Register Bit Descriptions (continued)

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has no effect during UART mode 0 operation. When this bit is cleared to 0, the OFS bit is

selected by the OFS bit to be output on the TXD0 pin for the asynchronous UART transmit modes (i.e., modes 1, 2, and 3). Note that the PWM function is not possible for UART mode 0 and this bit

SMD0.7: EPWM

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and 2 result from the last operation when MCW bit is 1 or the last operation is either multiply-only or multiply-negate. When MCW bit is 0 and the last operation is either multiply-accumulate or multiply-subtract, the contents of this register may or may not agree with the contents of MC1 due to the combinatorial nature of the adder. The contents of this register remain until a SFR content

related to the multiplier has been changed.

Special Function Register Bit Descriptions (continued)

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MC1R.[15:0]:

Special Function Register Bit Descriptions (continued)

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SMD1 (08h, 04h) **Serial Port Mode Register 1** Initialization: This register is cleared to 00h on all forms of reset. Read/Write Access: Unrestricted read/write. SMD1.0: FEDE **Framing-Error-Detection Enable.** This bit selects the function of SM0 (SCON1.7). FEDE = 0: SCON1.7 functions as SM0 for serial-port mode selection. FEDE = 1: SCON1.7 is converted to the FE flag. SMD1.1: SMOD **Serial Port 1 Baud-Rate Select.** The SMOD selects the final baud rate for the asynchronous mode. SMOD = 1: 16 times the baud clock for mode 1 and 3; 32 times the system clock for mode 2. $SMOD = 0$: 64 times the baud clock for mode 1 and 3; 64 times the system clock for mode 2. SMD1.2: ESI **Enable Serial Port 1 Interrupt.** Setting this bit to 1 enables interrupt requests generated by the RI or TI flags in SCON1. Clearing this bit to 0 disables the serial-port interrupt. SMD1.[7:3]: Reserved **Reserved.** Reads return 0. **PR1 (09h, 04h) Phase Register 1** Initialization: The phase register is cleared to 0000h on all forms of reset. Read/Write Access: Unrestricted read/write. PR1.[15:0]: **Phase Register 1 15:0.** This register is used to load and read the 16-bit value in the phase register that determines the baud rate for the serial port 1. **TB0CN (0Ah, 04h) Timer B 0 Control** Initialization: This register is cleared to 0000h on all forms of reset. Read/Write Access: Unrestricted read/write. TB0CN.0: CP/RLB **Capture/Reload Select.** This bit determines whether the capture or reload function is used for timer B. Timer B functions in an autoreload mode following each overflow/underflow. See the TFB bit description for overflow/underflow condition. Setting this bit to 1 causes a timer B capture to occur when a falling edge is detected on TBB if EXENB is 1. Clearing this bit to 0 causes an autoreload to occur when timer B overflow or a falling edge is detected on TBB if EXENB is 1. It is not intended that the timer B compare functionality should be used when operating in capture mode. TB0CN.1: ETB **Enable Timer B Interrupt.** Setting this bit to 1 enables the interrupt from the timer B TFB and EXFB flags in TB0CN. In timer B clock output mode (TBOE = 1), the timer overflow flag (TFB) is still set on an overflow; however, the TBOE = 1 condition prevents this flag from causing an interrupt when $ETB = 1$. TB0CN.2: TRB **Timer B Run Control.** This bit enables timer B operation when set to 1. Clearing this bit to 0 halts timer B operation and preserves the current count in TB0V. TB0CN.3: EXENB **Timer B External Enable.** Setting this bit to 1 enables the capture/reload function on the TBB pin for a negative transition (in upcounting mode). A reload results in TB0V being reset to 0000h. Clearing this bit to 0 causes timer B to ignore all external events on TBB pin. When operating in autoreload mode (CP/ $\overline{RLB} = 0$) with the PWM output functionality enabled, enabling the TBB input function (EXENB = 1) allows the PWM output negative transitions to set the EXFB flag. However, no reload occurs as a result of the external negative-edge detection. TB0CN.4: DCEN **Down-Count Enable.** This bit, in conjunction with the TBB pin, controls the direction that timer B counts in 16-bit autoreload mode. Clearing this bit to 0 causes timer B to count up only. Setting this bit to 1 enables the up/down counting mode (i.e., it causes timer B to count up if the TBB pin is 1 and to count down if the TBB pin is 0). When timer B PWM output mode functionality is enabled along with up/down counting (DCEN $= 1$), the up/down count control of timer B is controlled internally based upon the count in relation to the register settings. In the compare

modes, the DCEN bit controls whether the timer counts up and resets (DCEN = 0), or counts up and

Special Function Register Bit Descriptions (continued)

down ($DCEN = 1$).

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Special Function Register Bit Descriptions (continued)

Peripherals

This section contains detailed descriptions for each peripheral device, however, many of the peripherals are described in detail in the MAXQ Family User's Guide.

Most of the peripheral devices on the MAXQ3108 require connections to other components. To minimize the pin count, some peripherals share pins with other peripherals. Obviously, only one peripheral can drive a pin at any given time. Table 5 provides information on how to use these multipurpose pins.

Table 5. Multipurpose Pin Description

PIN	PRIMARY	SECONDARY	TERTIARY	COMMENT
	P _{2.0}	MDIN2P	MOSI	Do not enable both Manchester decoder 2 and SPI at the same time. If neither is enabled, the GPIO port function is used.
	POO	TXDO	INTO	Transmit data is only presented to the pin when a character is actually being transmitted. To use this pin as full-time transmit data, set the GPIO port pin to output and load a 1 in the output register. Do not enable an interrupt on this pin if it is used for the serial transmit function.
З	PO 1	RXD0	INT ₁	Receive data function is only operational when the associated REN bit is set is the SCON0 register. Do not enable an interrupt on this pin if it is used for the serial receive function.
4	P ₀ 2	MDIN1N	T ₂ P	Do not enable outputs or clock gating on timer 2 when Manchester decoder 1 is enabled. Also, do not enable INT2 when Manchester decoder 1 is enabled or clock gating is used on timer 2.

Pins

Table 5. Multipurpose Pin Description (continued)

Clock

All functional units in the MAXQ3108 are synchronized to the system clock. The system clock can be generated from an internal oscillator with a 32,768Hz external crystal/resonator or an internal FLL oscillator. The basic unit of time in the MAXQ3108 is the system clock period. The UserCore receives a system clock that is onehalf the internal clock frequency. The Manchester decoders, cubic sinc filters, and the DSPCore all receive the undivided system clock.

The internal clock circuitry generates the system clock from one of the two clock sources:

• Internal oscillator with a 32,768Hz external crystal or resonator

• Internal FLL, optionally driven by the 32,768Hz external crystal or resonator

The 32,768Hz external crystal provides the clock reference for functional units that require a fixed frequency. When the 32,768Hz clock reference is used directly as the system clock, the MAXQ3108 is operating in powersaving mode.

When not operating in power-saving mode, the MAXQ3108 receives its clock from the FLL. Because the MAXQ3108 has no way to receive a high-frequency clock from an external crystal or other source, the FLL is the only source of a high-frequency clock.

The FLL must be selected as the clock source for normal operation. This selection is made through the FLLSL bit. The FLLSL bit controls selection of the internal FLL oscillator for system clock generation. When $FLLSL = 1$, the internal FLL oscillator is used for system clock generation. The FLLSL bit is read/write accessible at any time and defaults to logic 0 on power-on reset only. **One of the first tasks user software should perform is to set the FLLSL bit to 1.**

During a power-on reset, the 32,768Hz crystal amplifier is automatically enabled. To disable the internal crystal amplifier, the RCNT.X32D bit must be set to 1. Once the 32,768Hz crystal amplifier is enabled, 250ms is required for it to warm up. The RCNT.32KRDY bit is set to 1 once the 32,768Hz amplifier has been given sufficient time to warm up.

32,768Hz Crystal Oscillator

The external 32K clock source can operate in different modes according to the setting of the 32K mode bits (RCNT.32KMD). In normal operation, the 32K oscillator is operating in the noise immune mode $(32KMD = 00)$, which is more tolerant to system noise. If the system is operating in a very quiet environment, the oscillator can be switched to quiet mode $(32KMD = 01)$ with reduced current consumption. Note that in this mode, the oscillator is subject to system noise and may not be desirable for very accurate timing requirement.

For applications where low stop-mode current is desired, there is an option to invoke the quiet mode operation during stop mode. When $32KMD = 1x$, the quiet mode is invoked on entry to stop mode. If 32KMD $= 10$ and 32K is enabled (X32D $= 0$), the CPU is held in stop mode until the 32K oscillator has warmed up $(32KRDY = 1)$. If $32KMD = 11$, the CPU starts execution from the selected clock source after the required FLL cycles requirement, in parallel with the oscillator warmup (transition from quiet mode to noise immune mode).

When the 32K input is enabled $(X32D = 0)$, changes of the 32KMD bits reset the 32KRDY bit if the 32K circuitry is already opening in the quiet mode and the new setting requires to change to noise immune mode. When the oscillator is operating in quiet mode, no warmup time is required and, therefore, 32KRDY is always set to 1. If the operation mode is changed to noise immune mode from the quiet mode, the 32KRDY bit is reset to 0. The 32KRDY bit is set to 1 after the necessary warmup time requirement.

Frequency-Locked Loop (FLL)

The internal FLL offers the least expensive solution for clock generation. The FLL provides a maximum frequency of 306 times the CX1 input clock (32.768kHz x $306 = 10.027$ MHz) with $\pm 5%$ when locked with 32.768kHz quartz crystal source. The lock period for the FLL is about 64 cycles of the CX1 input clock (approximately 2ms).

Controlling the FLL: The FLL has a lock-enable bit (FLLEN) to initiate the locking mechanism to the 32K input source. The FLOCK bit indicates to the user that the FLL is locked and ready to be used. The FLL has a short warmup period where the FLL is running but is not locked. The FLOCK bit indicates that the FLL is running and locked to the CX1 input. The FLL oscillator clock is divided down according to the PMME.

Internal clocks are generated directly from the system clock. Normally, the system clock is sourced from one of the two clock sources. The effect of the PMME and CD bits on the system clock in the MAXQ3108 is summarized in Table 6.

When the 32,768Hz clock is selected as the system clock source (PMME, CD1, CD0 = 111b), the system is running at PMM2 mode and all functional units are running synchronously. In this mode of operation, the highfrequency clock source is turned off to save power if the switchback function is not enabled (SWB $= 0$) unless the DSPCore is enabled; if the switchback is enabled (SWB $= 1$), the high-frequency clock source is not turned off (see the PMME bit description for more information). Note that debug mode does not work with PMM2 mode since switchback does not occur fast enough to guarantee proper operation.

Power Conservation

The MAXQ3108 incorporates power-management features that support low-power operation with three power-saving modes. Features include startup timer, internal FLL oscillator, and switchback function.

The MAXQ3108 was developed for low-power applications and has three different levels of power-saving

Table 6. MAXQ3108 Clock Divisors

modes. The two power-management modes reduce speed and power consumption by either internally dividing the clock signal by 256 or using the 32kHz clock directly. The stop mode stops all internal clocks (with the exception of the 32kHz crystal amplifier) resulting in a static condition and providing the lowest power state.

The power supervisor monitors the V_{DD} level when power is first applied to the device and generates a power-on reset when the voltage reaches an acceptable level, and following the 65,536 FLL cycle power-up period.

The power-on reset initializes the processor and allows program execution at the reset vector location of 8000h. The power-on reset flag, POR, is set to logic 1 to indicate a power-on reset has occurred; the POR flag can only be cleared by software.

Power-Management Mode

Power-management mode (PMM) allows application software to dynamically match operating frequency with the need for lower operating power when full processing throughput is not required. When power-management mode 1 (PMM1) is used, the system clock is divided by 256, resulting in a user core clock rate of 19.584kHz. When power-management mode 2 (PMM2) is used, the system clock is driven directly by the 32,768Hz clock source resulting in a user core clock of 16.384kHz.

PMM reduces operating power by minimizing power loss due to CMOS switching transients. PMM is invoked by setting the PMM enable bit (PMME). The PMME bit defaults to 0 on all forms of reset.

When the system is operated in PMM2 mode, the highfrequency clock is disabled unless the switchback is active or the DSPCore is enabled. Refer to the PMME bit description in the MAXQ Family User's Guide for more information.

Switchback The switchback feature allows low-power operation associated with PMM, but maintains quick response to events that require full processing capacity. The switchback function is enabled by setting the SWB bit to logic 1. When operating in a PMM mode and the SWB bit is enabled, the system restores the clock settings that were active when PMM was invoked whenever the system detects a qualified event.

The automatic switchback is only enabled when PMM is in use. Switchback to the high-frequency clock occurs whenever any of these conditions occur:

- Detection of a selected edge transition on any of the external interrupts when the respective pin has interrupts enabled.
- UART activity:
	- When the serial port is enabled to receive data and a transition occurs on the receive input pin (for mode 1, 2, and 3).
	- After a write access to the SBUF register.
- SPI activity:
	- SPIB is written in master mode (STBY = 1).
	- The SSEL signal is asserted in slave mode.
- Time-of-day alarm or subsecond alarm from the RTC when enabled.
- \bullet I²C activity:
	- Start interrupt when enabled (I2CSRIE = 1).
	- A write to the I2CSTART bit when the I2C controller is in master mode (I2CMST = 1).
- SVM interrupt if enabled (SVMIE = 1).
- Changing the value of ADCONV from 0 to 1.
- Active debug mode is entered either by breakpoint match or issuance of the debug command from background mode.

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Since PMM is incompatible with any operation that requires a precise clock (for example, baud-rate generation), attempts to set the PMME bit while such operations are active will fail.

Note that when switchback is enabled in PMM2 mode, the high-frequency clock (the FLL) continues to run to support the switchback operation.

Stop Mode

The stop-mode bit is only implemented for the MAXQ3108 UserCore (the DSPCore does not support stop mode). Stop mode disables all circuits within the processor except the 32,768Hz crystal amplifier and any circuitry that is directly clocked by the 32,768Hz oscillator. All other on-chip clocks, timers, and serial port communication are stopped, and no processing is possible. Once in stop mode, the device is in a static state, its power consumption primarily dominated by leakage current.

Stop mode is invoked by setting the STOP bit to logic 1. The processor enters the stop mode on the instruction that sets the STOP bit. Entering the stop mode does not affect the setting of the clock control bits, allowing the system to return to its original operating frequency after stop mode is exited. If reset ends stop mode, the clock generation logic is returned to its default condition.

The processor can exit stop mode through the following:

- By using any of the external interrupts that are enabled.
- By external reset through the RST pin.
- By the time-of-day alarm or subsecond alarm from the RTC.
- By the I2C start interrupt if enabled (I2CSRIE = 1 and $I2CEN = 1$).
- By the SVM interrrupt if enabled (SVMIE $= 1$).

When stop mode is exited, the processor resumes its normal execution. When the UserCore invokes stop mode, the DSPCore is disabled in hardware. This means that on any exit from stop mode, the DSP must be reconfigured and reenabled if this functionality is desired. This also means that user code may need to handle an interrupt source differently depending on whether it occurs while both CPUs are running or whether it removes stop mode.

Idle Mode Idle mode is only implemented for the MAXQ3108 DSPCore (not the UserCore). Idle mode suspends the processor by holding the instruction pointer (IP) in a static state. No instructions are fetched and no processing occurs. Setting the IDLE bit to logic 1 invokes the idle mode. The instruction that executes this step is the last instruction prior to freezing the program counter. Once in idle mode, all resources are preserved and clocks remain active to enabled peripherals so the processor can exit the idle state using any of the interrupt sources that are enabled. Note that the only interrupts associated with the DSPCore (i.e., those that can remove idle mode) are master request (from UserCore), and ADC output buffer interrupts. The IDLE bit is cleared automatically once the idle state is exited; allowing the processor to execute the instruction at the corresponding interrupt vector address. Upon returning from the interrupt vector, the processor executes the instruction that immediately follows the one that set the IDLE bit. Resetting the processor also removes the idle mode. Reset places the processor in a reset state and clears the IDLE bit. The DSPCore reset state could result from a global system reset or from clearing of the ENDSP bit by the UserCore.

Reset

The MAXQ3108 has four ways of entering a reset state:

- Power-on reset
- Watchdog timer reset
- External reset
- Internal system reset

Regardless of the reset source, the state of the MAXQ3108 is the same while in reset. When in reset, the oscillator/FLL oscillator is running, but no program execution is allowed. When the reset source is external, the user must remove the reset stimulus. When power is applied to the device, the power-on delay removes the stimulus automatically.

Power-On Reset/Brownout Reset Generation The MAXQ3108 incorporates an internal voltage reference and comparator in order to monitor V_{DD} and hold the device in reset if the supply is out of tolerance. Once V_{DD} has risen above the threshold, the MAXQ3108 generates a power-on reset, starts the internal FLL, and counts 65,536 FLL cycles (POR delay) before program execution begins at location 8000h. The power monitor invokes the reset state whenever the supply drops below the POR threshold. This reset condition remains until the supply voltage is above the minimum operating voltage level. When power returns above the reset threshold, a full power-on reset is performed. Thus, a brownout that causes V_{DD} to drop below the minimum voltage appears the same as a power-up.

The MAXQ3108 provides a brownout detect/reset function. Brownout detection is always enabled during

active mode. The power monitor invokes a brownout reset state to halt program execution when V_{DD} drops below the threshold condition. This ensures that the microcontroller is safely placed into a reset state whenever V_{DD} < V_{RST} , thus preventing possible code execution while the supply voltage is too low. When power returns above the reset threshold, and once the internal POR delay (65,536 FLL cycles) is satisfied, the device is initialized just as though power was removed and reapplied.

The processor exits the reset condition automatically once VDD meets the minimum voltage requirement. Software can determine that a power-on reset has occurred by checking the power-on reset (POR) flag in the WDCN register. Software should clear the POR bit after reading it.

The brownout detect function can be disabled during stop mode using the brownout disable (BOD) bit in the PWCN register. The POR default state for the BOD bit is 0, which enables the brownout detect function during stop mode. If brownout detection is disabled during stop mode, the circuitry responsible for detecting a brownout condition is shut down and the $V_{DD} < V_{RST}$ condition does not invoke the reset state. Since functionality of the device is not guaranteed when $V_{DD} < V_{RST}$, it is the responsibility of the user to ensure that the supply voltage is above the minimum operating voltage range (VRST) defined for the device when exiting stop mode.

Watchdog Timer Reset

The watchdog timer is a free-running programmable timer. The watchdog supervises the processor operation by requiring software to clear the timer counter before the timeout expires. If the timer is enabled and software fails to clear it before this interval expires, the device is placed into a reset state. The reset state maintains for nine system clock cycles. Once the reset is removed, the processor resumes execution at address 8000h. Software can determine if a reset is caused by a watchdog timeout by checking the watchdog timer reset flag, WTRF, in the WDCN register. This flag must be cleared by software.

External Reset If the RST input is taken to logic 0, the device is forced into a reset state. An external reset is accomplished by holding the RST pin low at least four clock cycles while the oscillator/FLL oscillator is running. Once the reset state is invoked, it is maintained as long as RST is pulled to logic 0. When the RST pin is released to return to a high state, the processor exits the reset state within

12 clock cycles and begins execution at address 8000h.

If a reset state is applied while the processor is in stop mode, the reset causes the processor to exit the stop mode and forces the program counter to 8000h.

Reset Input Pin Disable

The external reset (RST) pin function on the MAXQ3108 can be disabled by user application code. The poweron-reset default condition is for the RST pin to be enabled. Some applications, however, may not use the reset input function or may use the alternate function assigned to the pin. The reset function on the external pin can be disabled by setting the RSTD bit of the PWCN register to a logic 1. Since the POR default condition for the device results in the RST function being enabled on the pin, users should be cautioned that holding the pin low on power-up prevents exiting of the reset state and the ability to execute the code necessary to disable the RST function. When the reset function is enabled on the RST pin, user code can generate a reset by writing a 0 to the port pin.

Peripheral Devices

GPIO Ports

The MAXQ3108 contains three GPIO ports: P0, P1, and P2. Internally, each of these ports is 8 bits wide; however, not all bits of all ports are connected to pins. Port P0 exposes bits 0 to 7, port P1 exposes bits 0 to 6, and port P2 exposes bits 0 to 5. Writes to unused bits have no effect. Reads from unused bits could be in an indeterminate state.

For information on using GPIO ports, refer to Section 6 of the MAXQ Family User's Guide.

UARTs

The MAXQ3108 contains two UARTs (universal synchronous/asynchronous receiver/transmitters). Most often, these are used as standard asynchronous serial ports for console applications; however, they are quite flexible and can be used in a variety of ways.

Each port can be configured through the control register (SCONx) and the mode register (SMDx). The baud rate is established by programming an appropriate value in the phase register (PRx). Finally, communication is performed by writing and reading the buffer register (SBUFx).

Details on using these ports can be found in Section 10 of the MAXQ Family User's Guide. Note that the multiprocessor support mentioned in this document is **not** supported by the serial ports implemented in the MAXQ3108.

Figure 2. IR Option on UART 0

Infrared Support

UART channel 0 on the MAXQ3108 contains a special feature that eases its use with some infrared communication systems. In these systems, an asynchronous serial signal is used to on-off modulate a high-frequency carrier signal. This modulated carrier is then used to further modulate an IR beam. Because of the popularity of infrared remote controls, the receivers for this sort of modulated signal are readily available and inexpensive.

Signal Description: To convert an asynchronous signal into a signal suitable for IR transmission, the modulated IR beam is typically turned on during "0" bit times, and is turned off during "1" bit times. For conventional serial data, this means that the IR beam is on only when data is actually being transmitted, and is off at all other times. See Figure 2.

Because drivers for the IR LED used as a transmitter vary, there are two additional bits in the SMD0 register to configure the output signal. The first is the EPWM bit. When set, the output of the lower half of timer 2 is mixed with the transmitted serial data signal. The resulting waveform has the output frequency from the timer when the data signal is low, and has either a low or high level when the data signal is high.

The state of the output when the serial data signal is high is set by the OFS bit in the SMD0 register. When the OFS bit is 0, the TxD0 pin is low when the serial data signal is high; when the OFS bit is 1, the TxD0 pin is high when the serial data signal is high.

The carrier frequency is generated by the low half of timer 2 configured as two 8-bit timers. See the Timer 2 and Timer B sections for more information about configuring this timer.

SPI

The MAXQ3108 contains an SPI peripheral that can be configured as either a master or a slave. For information on the SPI peripheral, refer to Section 11 of the MAXQ Family User's Guide. Note that the SPI peripheral is not available when the ADC channels are used, since they share pins.

I2C Interface

The MAXQ3108 contains an I2C peripheral. The I2C bus is an 8-bit, bidirectional, 2-wire serial bus interface with the following characteristics:

- Compliant with Philips Semiconductor I2C bus specification version 2.1 (2000).
- Information is transferred through a serial data bus (SDA) and a serial clock line (SCL).
- Operates in either master or slave mode as transmitter or receiver.
- Supports a multimaster environment.
- Supports 7-bit and 10-bit addressing modes.
- Data transfer rate of up to 100kbps in standard mode and up to 400kbps in fast mode.
- On-chip filtering rejects spikes on the bus data line to preserve data integrity.
- Supports maximum bus capacitance of 400pF.

A transfer sequence, in its simplest form, is composed of a START bit (S), the slave address, a R/W bit, and an address-acknowledge bit (A) followed by data, a dataacknowledge bit (A), and a STOP bit (P). One party, the master, initiates the sequence and governs the timing.

The other party, the slave, recognizes its address and responds by accepting data or delivering data. A data transfer sequence can be grouped into the following stages:

- **START:** The master generates the START condition (S) by pulling SDA low (high-to-low transition) while holding SCL high.
- **Address:** The master transmits the address of the slave device, together with the direction of data transfer (R/W).
- **Address Acknowledge:** The slave with the matching address responds to the master by holding SDA low during the 9th clock SCL high (A).
- **Data:** The transmitter sends data to the receiver. The number of bytes of data is unlimited. However, each data byte must be followed by a data-acknowledge bit (A).
- **Data Acknowledge:** The receiver acknowledges to the transmitter by sending the acknowledge bit (A). If the master is the receiver and the data just received is the last byte expected, the master leaves SDA high to signal to the slave transmitter that the last byte of expected data is transmitted. The slave transmitter then releases SDA after the 9th clock so that the master can generate a STOP or START condition.
- **STOP:** The master concludes the transfer by sending the STOP condition (P) by causing a low-to-high transition on SDA while SCL is high. The I2C bus is now idle.

The MAXQ3108 I²C peripheral uses seven registers to manage I2C bus communication:

- **I2CBUF:** The buffer register through which all outbound data is written, and through which all inbound data is received.
- **I2CCK:** The I²C clock register defines the high and low periods for the SCL signal.
- **I2CCN:** The control register manages the I²C peripheral during configuration and operation.
- **I2CST:** The status register contains bits that reflect the condition of the $12C$ peripheral. It is consulted frequently during I2C operation.
- **I2CIE:** The interrupt enable register is used to manage interrupt sources within the I2C peripheral.
- **I2CTO:** The timeout register defines how long a slave can extend the I2C clock before the peripheral declares a timeout.
- **I2CSLA:** Establishes the slave address for the I2C peripheral.

I 2C Use Scenario: MAXQ3108 Master Sends 2 Bytes to Slave

- 1) Set the I2CEN and I2CMST bits in the I2CCN register. This enables the I2C peripheral and establishes the MAXQ3108 as master.
- 2) Set the I2CSTART bit in the I2CCN register. This causes the MAXQ3108 to send the START sequence. When the START condition has been sent (and both SDA and SCL are low), the I2CSTART bit is cleared. Note that the I2CSRI bit is set in the I2CST register as well. That is because the I2C peripheral sees its own START condition.
- 3) Load the command byte into I2CBUF. The command byte consists of the slave address and the R/\overline{W} bit. For this example, assume we wish to write to slave address 0x30. The byte to be loaded in this case is 0x60: the address shifted up by one position and bit 0 (the R \overline{W} bit) set to 0.
- 4) Monitor the I2CTXI flag in the I2CST register. When set, the I²C peripheral has finished sending the command byte and has received an ACK or a NAK from the remote device. Check the I2CNACKI flag in the I2CST register to determine if an ACK or a NAK was received. If set, the command was not acknowledged. Clear these bits after they are tested.
- 5) Load the first data byte into I2CBUF.
- 6) Monitor the I2CTXI flag in the I2CST register. When set, the I²C peripheral has finished sending the data byte. Check the I2CNACKI flag to ensure that the slave has received the byte. Clear both these bits.
- 7) Load the second data byte into I2CBUF.
- 8) Monitor the I2CTXI flag in the I2CST register. When set, the I²C peripheral has finished sending the data byte. Check the I2CNACKI flag to ensure that the slave has received the byte. Clear both these bits.
- 9) Set the I2CSTOP bit in the I2CCN register. This causes the MAXQ3108 to send the STOP sequence. When this bit returns to 0, the STOP sequence has been sent and the I2C bus is idle.

I 2C Use Scenario: MAXQ3108 Master Receives 2 Bytes from Slave

- 1) Set the I2CEN and I2CMST bits in the I2CCN register. This enables the I2C peripheral and establishes the MAXQ3108 as master.
- 2) Set the I2CSTART bit in the I2CCN register. This causes the MAXQ3108 to send the START sequence. When the START condition has been

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sent (and both SDA and SCL are low), the I2CSTART bit is cleared. Note that the I2CSRI bit is set in the I2CST register as well. That is because the I2C peripheral sees its own START condition.

- 3) Load the command byte into I2CBUF. The command byte consists of the slave address and the R/\overline{W} bit. For this example, assume we wish to write to slave address 0x30. The byte to be loaded in this case is 0x60: the address shifted up by one position and bit 0 (the R \overline{W} bit) set to a one.
- 4) Monitor the I2CTXI flag in the I2CST register. When set, the I²C peripheral has finished sending the command byte and has received an ACK or a NAK from the remote device. Check the I2CNACKI flag in the I2CST register to determine if an ACK or a NAK was received. If set, the command was not acknowledged. Clear these bits after they are tested.
- 5) Set the I2CACK bit to 0 to acknowledge the first byte.
- 6) Monitor the I2CRXI flag in the I2CST register. When set, the I²C peripheral has finished receiving the data byte and has sent the ACK. Read the data from the I2CBUF register and clear the I2CRXI bit.
- 7) Clear the I2CACK bit to NAK the next received byte.
- 8) Monitor the I2CRXI flag in the I2CST register. When set, the I²C peripheral has finished receiving the data byte and has sent the NAK. Read the data from the I2CBUF register and clear the I2CRXI bit.
- 9) Set the I2CSTOP bit in the I2CCN register. This causes the MAXQ3108 to send the STOP sequence. When this bit returns to 0, the STOP sequence has been sent and the I²C bus is idle.

I 2C Use Scenario: MAXQ3108 Slave Receives 2 Bytes from External Master

1) Set the I2CEN bit in the I2CCN register. This enables the I2C peripheral.

- 2) Set the slave address in the I2CSLA register.
- 3) Monitor I2CST. As conditions change on the I2C bus, they are reflected in the I2CST register. When the I2CAMI bit is set, the address of the MAXQ3108 has been matched. The MAXQ3108 automatically sends ACK when an address matches.
- 4) Set the I2CACK bit to 0 to ACK the received bytes.
- 5) Monitor the I2CRXI and the I2CSPI flags in the I2CST register. When the I2CRXI bit is set, the I2C peripheral has finished receiving the data byte and has sent the ACK. Read the data from the I2CBUF register and clear the I2CRXI bit.
- 6) When the I2CSPI flag is set, the I2C peripheral has detected a STOP condition. No more characters are to be expected.

ADC Inputs

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The MAXQ3108 contains six cubic sinc filters that receive decoded bit streams from three Manchester decoders. The ADC hardware is unique in that most of the functions can be performed by either the UserCore or the DSPCore. This section describes how these ADC inputs are configured. See Figure 3.

The input to the Manchester decoder is a composite signal consisting of two delta-sigma modulator channels and a synchronization signal. The decoder extracts the clock and data and presents the signals to a sync detector. This block searches for the synchronization pattern and keeps a shift register in step with the synchronized signal. When the sync detector is asserting a lock indication, the recovered channel 0 and 1 outputs reflect two analog inputs at the ADC modulator.

These recovered bit streams are presented to cubic sinc filters for conversion to digital format. The filters themselves have 24-bit resolution; however, the number of bits that are actually significant depends directly on the oversampling rate used in the filter control logic.

Figure 3. ADC Bit Stream Decoder

ADC Registers

- • **AD0 to AD5:** These six registers contain the most significant 16 bits for the cubic sinc filters. AD0 and AD1 correspond to Manchester decoder 0, AD2 and AD3 correspond to Manchester decoder 1, and AD4 and AD5 correspond to Manchester decoder 2.
- **AD0LSB to AD5LSB:** These six registers contain the least significant 8 bits for the cubic sinc filters. Paired with the AD0 to AD5 registers, each cubic sinc filter has 24 bits of resolution.
- **ADCN:** The ADC control register contains both control bits and status bits associated with the ADC. The register contains bits that configure the oversampling rate, and enable or disable individual Manchester decoder channels and interrupts and other functions.
- **ADCC:** This register contains a measure of the clock rate associated with a particular Manchester decoder. Because the speed of a Manchester channel is controlled not by the MAXQ3108 but by the unsynchronized clock of an external device, it is critical for the application to know the difference between the modulator clock and the MAXQ3108 clock. To determine this, the ADCC register contains the number of sync bits that occur during 512 32.768kHz clock periods. Application software can use this information to determine the relative speed of the two clocks and to make correction for time-critical measurements.
- **MSTC:** The Manchester decoder status register contains bits that reveal the synchronization status of all three Manchester decoders. It also contains the selection bits for the clock measurement function exposed in the ADCC register.

Use Case: Using a Single DS8102 as a 2-Channel ADC

The DS8102 is designed to operate with the Manchester data inputs of the MAXQ3108. Figure 4 demonstrates how simple the physical interface can be: just connect the MNOUT pin of the DS8102 to the MDIN0P input of the MAXQ3108, and establish a common ground using the MDIN0N pin. This interface point, however, makes an ideal isolation interface. Because of the Manchester-encoded nature of the signal interface, any type of isolation—capacitive, transformer, or optical—can be used to couple the output of the DS8102 to the MAXQ3108.

To use the ADC inputs, perform the following steps:

- Configure the ADC. In the ADCN register, set the OSR bits to select the desired oversampling rate, either 32, 64, 128, or 256. Enable the Manchester decoder 0 by setting MD0E.
- Within a few milliseconds, the MD0SNC bit should go active in the MSTC register. This indicates that the synchronization pattern has been detected and that samples in the AD0 register are valid.
- To read samples, wait for ABF0 to go active in the ADCN register. This indicates that samples are available in the AD0 and AD1 registers. The sample input loop can be as simple as:

while(TRUE)

ί.

}

```
while(!ADCN.ABF0);
process_sample(AD0);
```


The MAXQ3108 contains two MAXQ20 cores. The first core, UserCore, operates at half the master clock speed and manages most of the peripheral devices. The second core, DSPCore, operates at the full master clock speed and has no peripheral responsibility. It is free to handle most of the math-intensive parts of the application.

The DSPCore differs from the UserCore in two important aspects: first, it has no debug engine; and second, it has no nonvolatile program memory. Instead, the

Figure 4. Connecting the MAXQ3108 to a DS8102 Dual Delta-Sigma Modulator

DSPCore uses 8KB (4K instruction words) of RAM as code memory, with a separate 1KB (512 word) data space.

DSP Code Memory

Code memory for the DSPCore is implemented as an 8KB block of static RAM. Following power-on reset, the DSPCore CPU is disabled (that is, ENDSP is clear). Since the DSPCore is not fetching instructions, its code memory can be remapped to the UserCore data space. The DSPCore code RAM is mapped into UserCore data space at 0x1000–0x2FFF in byte mode (or 0x1000–0x1FFF in word mode).

Code for the DSPCore must be compiled along with the code for the UserCore as an independent, self-contained module. That is, the DSPCore code cannot contain calls to modules in the UserCore and cannot depend on any C runtime code that is executed only in the UserCore. For this reason, it is likely that development for the DSPCore is done in assembly language rather than C. Code for the DSPCore must be compiled to run at location 0x8000 and must be located in a segment with a known absolute address.

To configure DSP code memory at runtime using the utility ROM copy routines:

- Establish a word array at location 0x1000.
- Establish a word pointer (DP[0]) at the start of the DSPCore code block in flash.
- Add 0x8000 to DP[0].
- Call the utility ROM function UROM_moveDPinc.
- Copy the result to the word array and increment the array pointer.
- Repeat until complete.

Once the copy is complete, setting the ENDSP bit relocates the RAM block from 0x1000 in UserCore data space to 0x8000 in DSPCore code space and releases DSPCore reset. When DSPCore reset is released, the DSPCore begins executing instructions from the RAM block at 0x8000.

Intercore Communications

A set of five registers is used to communicate between the UserCore and the DSPCore. Three registers, MREQ0, MREQ1 and MREQ2, are dedicated to communicating requests from the UserCore to the DSPCore; two registers, SRSP0 and SRSP1, manage responses from the DSPCore to the UserCore.

The UserCore starts all communication between the two cores. Typically, the UserCore and the DSPCore agree on a set of 4-bit request codes that the DSPCore recognizes and to which it responds. For example, request code 1 might be a software reset; request code 2 might be a read RAM request; request code 3 might be a write RAM request.

A set of hardware locks keep the two cores in synchronization for purposes of communication. The REQCDV (request command data valid) bit in the MREQ0 is set by the UserCore to alert the DSPCore that a request is pending. When the DSPCore has read the request, it can clear the REQCDV bit. Only the DSPCore can clear the bit; thus, coherency is guaranteed. Similarly, when the DSPCore has a response available it sets the RSPSDV (response status data valid). When the UserCore has received the response data, it clears the RSPSDV bit. Since only the DSPCore can set this bit and only the UserCore can clear it, once again, coherency is guaranteed.

A typical use-case scenario would proceed as follows.

Case 1: Load the 16-bit value 0x55AA to RAM location 0x0020 in the DSPCore. It has been established that the command for RAM write is 0x03.

- 1) The UserCore loads the 16-bit address 0x0020 into MREQ1 and the 16-bit data word 0x55AA into MREQ2.
- 2) The UserCore loads 0x23 into the MREQ0 register. This simultaneously loads the command 0x03 into the request command and sets the REQCDV bit to alert the DSPCore that a command is pending.
- 3) The DSPCore receives the alert that a command is pending and retrieves the command from the MREQ0 register. It decodes the request as a RAM write request (0x03.) In response, it reads MREQ1 for the address and MREQ2 for the data to write.
- 4) The DSPCore completes the RAM write operation.
- 5) The DSPCore then clears the REQCDV bit in the MREQ0 register to signal the successful execution of the command.

Case 2: Read the 16-bit value at DSPCore RAM location 0x0030. It has been established that the command for RAM read is 0x02.

- 1) The UserCore loads the 16-bit address 0x0030 into MREQ1.
- 2) The UserCore loads 0x22 into the MREQ0 register. This action simultaneously loads the command 0x02 into the request command and sets the REQCDV bit to alert the DSPCore that a command is pending.
- 3) The DSPCore receives the alert that a command is pending and retrieves the command from the

MREQ0 register. It decodes the request as a RAM read request (0x02.) In response, it reads MREQ1 for the address to read.

- 4) The DSPCore completes the RAM read operation.
- 5) The DSPCore loads the results of the read to the SRSP1 register.
- 6) The DSPCore loads 0x22 into the SRSP0 register. This action simultaneously loads the response 0x02 into the response bits and sets the RSPSDV bit to alert the UserCore that a response is pending.
- 7) The UserCore receives the response alert and retrieves the response from the SRSP1 register. It then clears the RSPSDV bit in the SRSP0 register.
- 8) The DSPCore sees that the RSPSDV bit is cleared. It then clears the REQCDV bit in the MREQ0 register.
- 9) The UserCore sees the REQCDV bit go clear and is now ready for the next request.

Timer 2 Timer 2 is a complex timing element designed for PWM generation, IR generation and detection, and a variety of other purposes. For information about this timer and its properties, refer to Section 9 of the MAXQ Family User's Guide.

The timer B peripheral is an enhanced timer type 1 (refer to the MAXQ Family User's Guide for information about type 0, type 1, and type 2 timers). It has many of the features of the more complex type 2 timer, but with an interface optimized for the 16-bit MAXQ architecture.

Timer B

Timer B is managed through four 16-bit registers: TB0CN is the configuration and status register; TB0V is the current value of the timer; TB0R is the capture/reload register; and TB0C is the compare register.

The bits of the configuration and status register are as follows:

Bit 0: CP/RLB. If cleared to 0, TB0R functions as a reload register. This means that TB0V is reloaded with the appropriate value when overflow/underflow occurs. (If counting up, TB0V is loaded with 0 when TB0V $=$ TB0R; if counting down, TB0V is loaded with TB0R when $TBOV = 0x0000$.) If set, the TB0R captures the value of TB0V when a falling edge is detected on TBB.

Bit 1: ETB. Enables all interrupts from timer B.

Bit 2: TRB. When set, timer B is allowed to run. When cleared, the time is halted with its current state intact.

Bit 3: EXENB. Setting this bit enables capture/reload functions on the TBB external pin. In capture mode, a negative transition on this pin copies the current value of the TB0V register into the TB0R register. In reload mode, a negative transition on this pin resets TB0V to 0 (in upcount mode) or to TB0R (in downcount mode).

Bit 4: DCEN. When clear, the counter or timer counts up. When set, the counter or timer counts either up or down depending on the state of the TBB pin. In PWM modes, the TBB pin is an output; in this case, when DCEN is active the counter counts up to TB0R, then counts down to 0 and repeats.

Bit 5: TBOE. When set, and when the timer is operating in timer mode, this bit enables the output of the timer onto the TBA pin. When clear, the TBA pin can be used for an alternate function, or as an input to the timer.

Bit 6: EXFB. This flag is used to trigger an interrupt on any of the following conditions:

- The timer is configured as a timer in capture mode, and a negative edge on the TBB pin is observed with the TBB pin enabled.
- The timer is configured in reload mode and counts up, and a negative edge on the TBB pin is observed with the TBB pin enabled.
- The timer is configured to any PWM operating mode and a negative edge on the TBB pin is observed with the TBB pin enabled.

Additionally, if reload mode is in effect with no PWM operating mode, the EXFB bit toggles on overflow/ underflow without generating an interrupt.

Bit 7: TFB. This flag is set on any overflow/underflow event. It must be cleared by software.

Bits 10 to 8: TBPS. These three bits define the prescaler divisor:

Bit 11: TBCR. Setting this bit enables PWM mode. If this bit is set (and TBCS is clear), the TBB pin is driven to 0 when TB0V = TB0C and driven to 1 when TB0V = TB0R. Setting both TBCS and TBCR causes TBB to toggle when TB0V = TB0C.

Bit 12: TBCS. Setting this bit enables PWM mode. If this bit is set (and TBCR is clear), the TBB pin is driven to 1 when TB0V = TB0C and driven to 0 when TB0V = TB0R. Setting both TBCS and TBCR causes TBB to toggle when TB0V = TB0C.

Bit 15: C/TB. When clear, the timer is configured as a timer (that is, it counts clock pulses from the prescaled system clock.) When set, the timer is configured as a counter; that is, it counts transitions on the TBA pin.

Timer B Use-Case Scenarios Case 1: Output 1kHz square wave on TBA.

In this instance, reload the timer at a 500µs interval (since a 1kHz square wave has an edge every 500µs. Since the default UserCore clock is 5.014MHz, the total divisor should be $5014kHz/2kHz = 2507$. Thus, a prescaler value of 1 and a TB0R value of 2507 (0x09CB) provides the necessary timing.

The procedure is as follows:

- Load TB0R with 0x09CB.
- Load TB0CN with 0x0024. This (1) sets the timer to timer mode, (2) disables PWM mode, (3) sets a prescaler divisor of 1, (4) disables the TXFB trigger, (5) enables square-wave output, (6) sets reload mode, and (7) disables any interrupts in the timer.

Case 2: Configure a PWM output with one part in 1000 resolution. Frequency is not critical.

In this instance, configure TB0R with a value of 1000. Configure TB0CN with 0x0804. This (1) sets the timer to timer mode, (2) enables PWM mode, (3) sets a prescaler divisor of 1, (4) disables the TXFB trigger, (5) disables square-wave output, (6) sets reload mode, and (7) disables interrupts.

Writing a value to TB0C sets the duty cycle of the output on TBB. When the TB0C value is 100, for example, the timer counts from 0 to 99 with the output high. When the timer reaches 100, the TB0C value is a match and the output goes low. The timer continues to run until it reaches 1000, at which time it switches low and reloads to 0.

Multiply-Accumulate Unit

The MAXQ3108 contains one multiply-accumulate unit for each CPU core. Each of these units can multiply two 16-bit numbers (signed or unsigned) in a single CPU cycle, and then accumulate the result to a 48-bit accumulator in a second cycle. Details on the multiply-accumulate units are available in Section 12 of the MAXQ Family User's Guide.

Real-Time Clock

The real-time clock is a 32-bit time-of-day clock that supports interrupt generation based on time intervals and time-of-day alarms. It is driven from the 32,768Hz crystal oscillator and operates even when the UserCore is in stop mode.

For information on the real-time clock module, refer to Section 14 of the MAXQ Family User's Guide.

Programmable Pulse Generators

The DSPCore has access to two precision, programmable pulse generators. Pulse generation is critical in electricity meters and other utility-based applications.

The principle of the pulse generator is simple: an output port is conditioned on a 22-bit counter so that when the counter is 0, the output port operates normally (that is, when a bit value is written to the port, the state of the pin changes); but when the counter is running, the pin is held at its previous state regardless of what value is written to it. The moment the counter reaches 0, however, the new value is transferred to the pin.

To use the pulse generator, write a 1 to the port and write a value to the counter. The counter begins counting down. While the counter is running, write a 0 to the port. Because the counter is running, the 0 is not immediately reflected on the pin. Only when the counter reaches 0 does the "0" level transfer to the pin. The practical value of this is the amount of time that the pin has been high is exactly a function of the value written to the counter.

In the MAXQ3108, the counter is 22 bits wide, but only the high-order 16 bits are writable. The other 6 bits are cleared on any write. Thus, the maximum value that can be written to the register is 0x3FFFC0, or, at the default clock rate of the DSPCore (10.027MHz) about 418ms.

In-Application Flash Programming

From user code, flash is programmed using the ROM utility functions from either C or assembly language. The flash can be programmed one word at a time if so desired. Once a new user code routine has been programmed and verified in flash, the link or call address to that routine can be enabled. This procedure allows continued user code execution while dynamic reconfiguration of user billing code and tariff schedules occurs. The initial application code loaded through JTAG dictates the in-application facility and implements recognition of the in-application request and communication. The following function declarations show examples of some of the ROM utility functions provided for in-application flash programming.

/* Write one 16-bit word to code address 'dest'.

* Dest must be aligned to 16 bits.

```
* Returns 0 = \text{failure}, 1 = \text{OK}.
```
*/

int flash write (uint16 t dest, uint16 t data); To erase, the following function would be used:

```
/* Erase the given Flash page
```
* addr: Flash offset (anywhere within page) */

```
int flash erasepage(uint16 t addr);
```
Development and Technical Support

A variety of highly versatile, affordably priced development tools for this microcontroller are available from Maxim and third-party suppliers, including:

- Compilers
- In-circuit emulators
- Integrated development environments (IDEs)
- JTAG-to-serial converters for programming and debugging

A partial list of development tool vendors can be found on our website at **www.maxim-ic.com/MAXQ_tools**.

For technical support, go to **https://support.maximic.com/micro**.

Additional Documentation

Designers must have three documents to fully use all the features of this device. This data sheet contains pin descriptions, feature overviews, and electrical specifications. Errata sheets contain deviations from published specifications. The MAXQ Family User's Guide offers detailed information about device features and operation.

- This MAXQ3108 data sheet, which contains electrical/timing specifications and pin descriptions.
- The MAXQ3108 errata sheet for the specific device revision, available at **www.maxim-ic.com/errata**.
- The MAXQ Family User's Guide, which contains detailed information on core features and operation, including programming. This document is available on our website at **www.maxim-ic.com/MAXQUG**.

Pin Configuration

Package Information

For the latest package outline information and land patterns, go to **www.maxim-ic.com/packages**.

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